

FEATURES

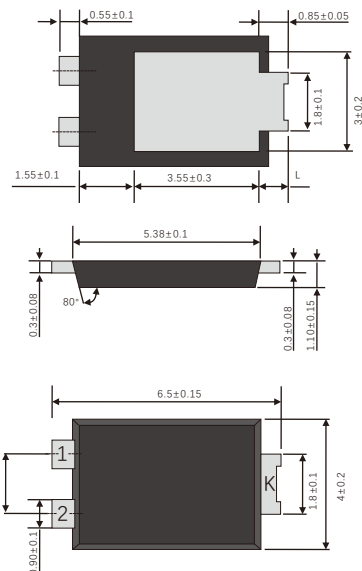
- Plastic package has Underwriters Laboratory Flammability Classification 94V-0
- Metal silicon junction ,majority carrier conduction
- Guard ring for overvoltage protection
- Low power loss ,high efficiency
- High current capability ,low forward voltage drop
- High surge capability
- Very low profile-typical height of 1.1mm
- Ideal for automated placement
- High temperature soldering guaranteed:260°C/10 seconds at terminals
- Component in accordance to RoHS 2015/863/EU



MECHANICAL DATA

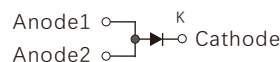
- Case: TO-277 molded plastic body
- Terminals: Plated axial leads, solderable per MIL-STD-750,method 2026
- Mounting Position: Any
- Weight: 0.092 grams(approx)

TO-277



TYPICAL APPLICATIONS

For use in low voltage ,high frequency inverters ,DC/DC converters, free wheeling ,and polarity protection applications



Dimensions in inches and (millimeters)

MAXIMUM RATINGS

(Ratings at 25°C ambient temperature unless otherwise specified)

Parameter	Symbol	Value	Unit
Maximum repetitive peak reverse voltage	V_{RRM}	100	V
Maximum average forward rectified current	$I_F(AV)$	20.0	A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC method at rated TL)	I_{FSM}	200	A
Operating junction temperature range	T_J	-55 to +150	°C
Storage temperature range	T_{stg}	-55 to +150	°C

ELECTRICAL CHARACTERISTICS (T_A=25°C Unless otherwise noted)

Parameter	Test Conditions		Symbol	TYP.	MAX.	Unit
Instantaneous forward voltage	T _J =25°C	I _F =20A	V _F ¹⁾	0.70	0.75	V
		I _F =10A		0.56	-	
		I _F =5A		0.47	-	
	T _J =125°C	I _F =20A		0.64	-	
		I _F =10A		0.51	-	
		I _F =5A		0.40	-	
Reverse current	V _R =100V	T _J =25°C	I _R ²⁾	20	50	μA
		T _J =100°C		-	5	mA
		T _J =125°C		-	20	
Typical junction capacitance	4V,1MHz		C _J	1200		pF

Notes: 1.Pulse test: 300 μs pulse width,1% duty cycle

2.Pulse test: pulse width≤40ms

THERMAL CHARACTERISTICS

Parameter	Symbol	TO-277	Unit
Typical thermal resistance ³⁾	R _{θJA} ⁴⁾	60.0	°C/W
	R _{θJL}	3.0	

3 Units mounted on recommended PCB 1 oz. Pad layout

4 The heat generated must be less than thermal conductivity from junction to ambient:dP_D/dt_J < 1/R_{θJA}

AVAILABLE PACK INFORMATION

Product code	Pack	Carton Size L×W×H(mm)	Inner Box Size L×W×H(mm)	Reel diameter (mm)	Inner Box Number	Reel Number Per A Inner Box	Part Number Per A Reel(K)	Quantity(carton) (K)
SP20U100L- TO-277	Reel	370×370×360	338×338×39	φ330	7	2	5	70

FIG.1-FORWARD CURRENT DERATING CURVE

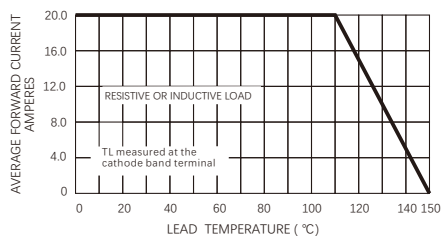


FIG.2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

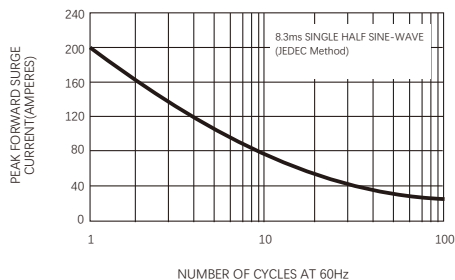


FIG.3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

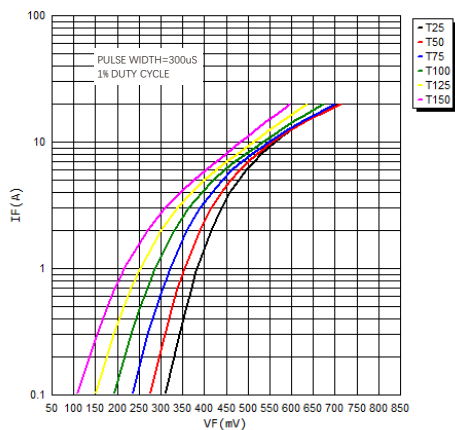


FIG.4-TYPICAL REVERSE CHARACTERISTICS

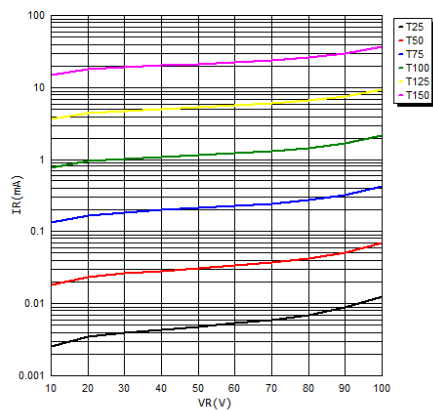
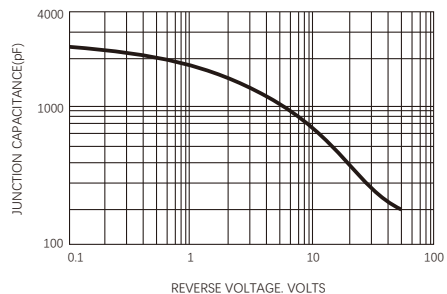


FIG.5-TYPICAL JUNCTION CAPACITANCE



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